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With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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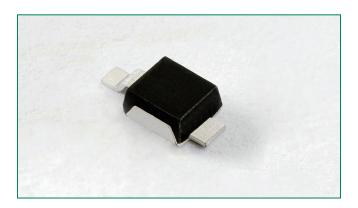




PLED Open LED Protectors PLED6M Series

PLED6M Series





Description

The open LED protector provides a switching electronic shunt path when an LED in an LED string fails as an open circuit. This ensures that the entire array of LEDs will continue to function even if a single LED in the array does not. This provides higher reliable lighting functions in applications such as headlights, aircraft lights, airport runway lighting, roadside warning lights, etc. This device is designed to be used with one watt LEDs, nominally 350mA @ 3V, and is available in POWERMITE®* package (CSP) which is ideal for dense board applications.

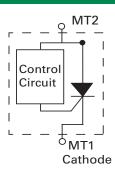
Pinout Diagram



Features & Benefits

- Fast switching
- Automatically resets after power cycle
- Available in low profile, small footprint POWERMITE® packages
- Compatible with industrial lighting environments
- Compatible with PWM frequencies up to 10 kHz
- RoHS compliant and halogen-free

Schematic Symbol



Electrical Characteristics(All parameters are measured at T_A=25°C unless otherwise noted)

Part Number	Marking	V _{BR} @I _{BR} = 1 mAmps		 _{LEAK} _{MT2} = 5V	I _H	l _s	I _T @V _T	V _T @I _T = 350mA	V _⊤ @I _⊤ =1A	V _T @I _T =1.3A	Critical rate of rise dV/dt	Capacitance @1MHz, 2V bias
Number		Vo	lts	uA	mA	mA	А	V	V	V	V	pF
		Min	Max	Max	Max	Max	Max	Max	Тур	Тур	Max	Max
PLED6M	P6M	5.5	7.5	250	12	70	1.0 1 2	1.2	1.15	1.2	250	24

Notes:

- 1) Standard FR-4 PCB with Copper Pads (2mm x 2mm/pad)
- 2) Aluminum PCB Pads (2mm x 3mm/pad)

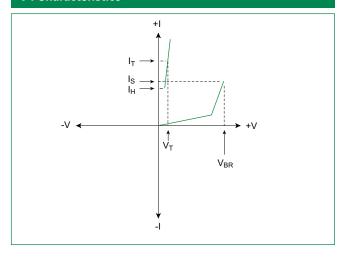
Thermal Considerations

Package	Symbol	Parameter	Value	Unit	
	I _T	Average On–State Current, $(T_A = 25^{\circ}C)$	1.0 1 2	А	
	V _T	On-state Voltage (T _A = 125°C)	1.0	V	
	D	Power Dissipation ($T_{\Delta} = 25^{\circ}$ C)	1.45 ¹	W	
Anode	P _D	Fower Dissipation (T _A = 25 C)	1.50 ²		
	T_{J}	Operating Junction Temperature Range	80 1	°C	
POWERMITE		Operating Junction Temperature Hange	50 ²		
	T _s Storage Temperature Range		-65 to +150	°C	
	R _{eJL}	Thermal Resistance: Junction to Lead	25 ¹	°C/W	
		mermai nesistance. Junction to Lead	20 ²		
	B	Thermal Resistance: Junction to Ambient	80 ¹		
	R _{eja}	merrial nesistance. Junction to Ambient	50 ²		

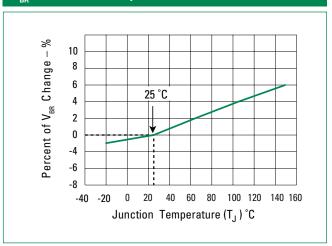
Notes

- 1) Standard FR-4 PCB with Copper Pads (2mm x 2mm/pad)
- 2) Aluminum PCB Pads (2mm x 3mm/pad)
- * POWERMITE® is a registered trademark of Microsemi Corporation.

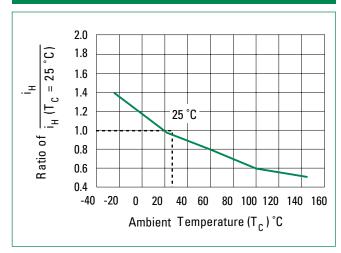
V-I Characteristics



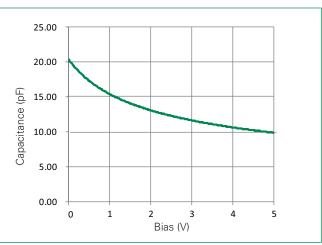
V_{BR} vs. Junction Temperature



Normalized DC Holding Current vs. Ambient Temperature

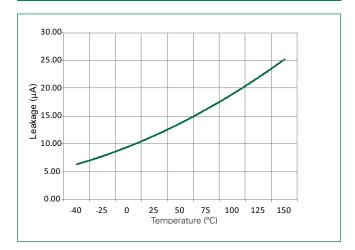


Capacitance vs Voltage

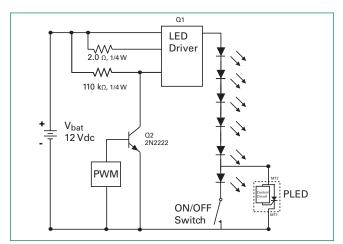




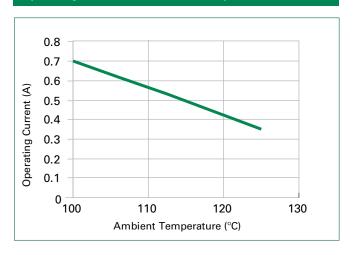
Leakage Current vs Temperature



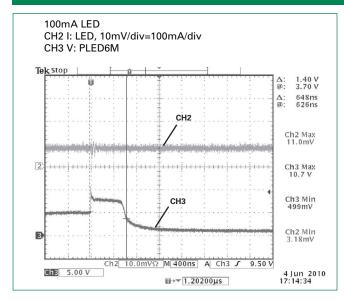
LED Interference Test Circuit

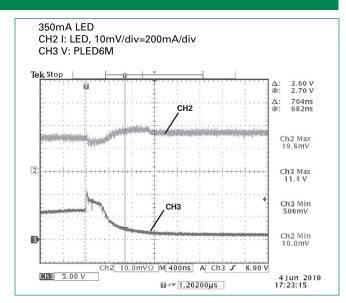


Operating Current vs. Ambient Temperature



Typical Operation Waveforms

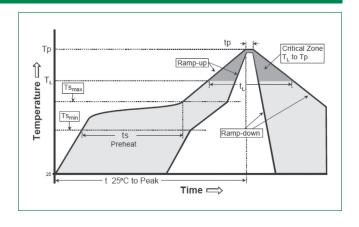




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Soldering Parameters

Reflow Co	ndition	Pb – Free assembly		
	-Temperature Min (T _{s(min)})	150°C		
Pre Heat	-Temperature Max (T _{s(max)})	200°C		
	-Time (min to max) (t _s)	60 – 180 secs		
Average ra	amp up rate (LiquidusTemp k	3°C/second max		
T _{S(max)} to T _L	- Ramp-up Rate	3°C/second max		
Reflow	-Temperature (T _L) (Liquidus)	217°C		
nellow	-Temperature (t _L)	60 – 150 seconds		
PeakTemp	erature (T _P)	260+0/-5 °C		
Time with Temperatu	in 5°C of actual peak ıre (t _p)	30 seconds		
Ramp-dov	vn Rate	6°C/second max		
Time 25°C	to peak Temperature (T _P)	8 minutes max		
Do not exc	ceed	260°C		



Physical Specifications

Terminal Material	Copper Alloy
Terminal Finish	100% Matte Tin Plated
Body Material	UL recognized epoxy meeting flammability classification 94V-0

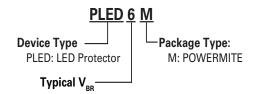
Packaging

Package Code	Description	Packaging Quantity	Industry Standard		
М	POWERMITE	3000	EIA-481-1 Tape and Reel		

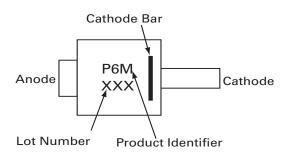
Environmental Specifications

High Temperature Voltage Blocking	MIL-STD-750: Method 1040, Condition A 80% min V _{BR} DC, 150°C, 504 hours
Temperature Cycling	MIL-STD-750: Method 1051 -65°C to 150°C, 15-minute dwell, 100 cycles
Biased Temperature & Humidity	EIA/JEDEC: JESD22-A101 80% min V _{BR} , 85°C, 85%RH, 1008 hours
Resistance to Solder Heat	MIL-STD-750: Method 2031 260°C, 10 seconds
Moisture Sensitivity Level	JEDEC-J-STD-020, Level 1
Burn-In Test	T _j = 150°C, IT = 0.350 Adc, 1008 hours

Part Numbering System

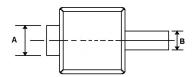


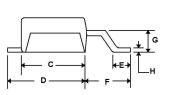
Part Marking System

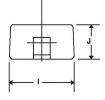


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Dimensions - POWERMITE® Package

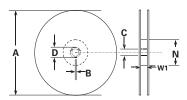




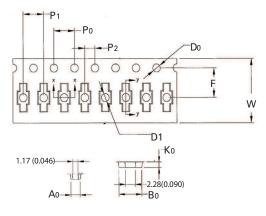


Dimensions	Millim	neters	Inches			
Dimensions	Min	Max	Min	Max		
А	0.73	0.99	0.029	0.039		
В	0.40	0.66	0.016	0.026		
С	1.77	2.03	0.070	0.080		
D	2.21	2.46	0.087	0.097		
Е	0.50	0.76	0.020	0.030		
F	1.29	1.54	0.051	0.061		
G	0.53	0.78	0.021	0.031		
Н	0.10	0.20	0.004	0.008		
Ī	1.77	2.03	0.070	0.080		
J	0.89	1.14	0.035	0.045		

Tape and Reel Specification - POWERMITE® Package



Reel Dimension



Complete la	Description		Inches		Millimeters		
Symbols	Description	MIN	TYP	MAX	MIN	TYP	MAX
А	Reel Diameter	-	-	7.087	-	-	180.00
В	Drive Spoke Width	0.098	0.157	0.217	2.50	4.00	5.50
С	Arbor Hole Diameter	0.504	0.512	0.520	12.80	13.00	13.20
D	Drive Spoke Diameter	0.795	-	-	20.20	-	-
N	Hub Diameter	2.343	2.362	2.382	59.50	60.00	60.50
W1	Reel Inner Width at Hub	0.472	0.488	0.508	12.00	12.40	12.90
A0	Pocket Width at Bottom	0.078	0.082	0.086	1.98	2.08	2.18
В0	Pocket Length at Bottom	0.198	0.202	0.206	5.04	5.14	5.24
D0	Feed Hole Diameter	0.055	0.059	0.063	1.40	1.50	1.60
D1	Pocket Hole Diameter	0.053	0.059	0.069	1.35	1.50	1.75
F	Feed Hole Center-Pocket Hole Center 2	0.197	0.217	0.236	5.00	5.50	1.60
K0	Pocket Depth	0.044	0.048	0.052	1.11	1.21	1.31
P0	Feed Hole Pitch	0.154	0.157	0.161	3.90	4.00	4.10
P1	Component Spacing	0.154	0.157	0.161	3.90	4.00	4.10
P2	Feed Hole Center-Pocket Hole Center 1	0.077	0.079	0.081	1.95	2.00	2.05
W	Embossed Carrier Tape Width	0.469	0.472	0.484	11.90	12.00	12.30
	Cover Tape Width	-	0.366	-	-	9.30	-